

N-Channel 60 V(D-S) MOSFET

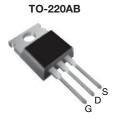
PRODUCT SUMMARY					
V _{DS} (V)	60				
R _{DS(on)} (Ω)	V _{GS} = 10 V 0.072				
Q _g max. (nC)	25				
Q _{gs} (nC)	5.8				
Q _{gd} (nC)	11				
Configuration	Single				

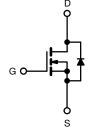
FEATURES

- Dynamic dV/dt rating
- Fast switching
- Ease of paralleling

Simple drive requirements







N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T _C	- 20°0, am		;			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V _{DS}	60	v	
Gate-Source Voltage			V _{GS}	± 20	V	
Continuous Drain Current	V_{GS} at 10 V $T_C = 1$ $T_C = 1$	T _C = 25 °C T _C = 100 °C	1-	20		
Continuous Drain Current		T _C = 100 °C	I _D	12	A	
Pulsed Drain Current ^a			I _{DM}	68	1	
Linear Derating Factor				0.40	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	100	mJ	
Maximum Power Dissipation	imum Power Dissipation $T_{\rm C} = 25 ^{\circ}{\rm C}$			60	W	
Peak Diode Recovery dV/dt ^c			dV/dt	4.5	V/ns	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +175	*0	
Soldering Recommendations (Peak temperature) ^d	d for 10 s			300	°C	
Mounting Torque	6.00 or 1	0.00		10	lbf ∙ in	
Mounting Torque	6-32 or M3 screw			1.1	N⋅m	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. V_{DD} = 25 V, starting T_J = 25 °C, L = 403 µH, R_g = 25 Ω , I_{AS} = 17 A (see fig. 12).
- c. $I_{SD} \le 17$ A, dI/dt ≤ 140 A/µs, $V_{DD} \le V_{DS}$, $T_J \le 175$ °C.
- d. 1.6 mm from case.



THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-	62		
Case-to-Sink, Flat, Greased Surface	R _{thCS}	0.50	-	°C/W	
Maximum Junction-to-Case (Drain)	R _{thJC}	-	2.5		

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static					•		
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μΑ	60	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I _D = 1 mA	-	0.061	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μA	1.0	-	3.0	V
Gate-Source Leakage	I _{GSS}	,	$V_{GS} = \pm 20 V$	-	-	± 100	nA
Zero Gate Voltage Drain Current	Inco	V _{DS} :	= 60 V, V _{GS} = 0 V	-	-	25	μA
Zero date voltage brain ourrent	I _{DSS}	V _{DS} = 48 V,	$V_{GS} = 0 V, T_J = 150 \ ^{\circ}C$	-	-	250	μΛ
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 10 V$	I _D = 10 A ^b	-	0.072	-	Ω
Forward Transconductance	9 _{fs}	V _{DS}	= 25 V, I _D = 10 A	5.5	-	-	S
Dynamic							
Input Capacitance	C _{iss}		$V_{GS} = 0 V,$	-	640	-	
Output Capacitance	C _{oss}		$V_{DS} = 25 V,$	-	360	-	pF
Reverse Transfer Capacitance	C _{rss}	t = 1.	0 MHz, see fig. 5	-	79	-	
Total Gate Charge	Qg			-	-	25	
Gate-Source Charge	Q_gs	$V_{GS} = 10 V$	$I_D = 17 \text{ A}, V_{DS} = 48 \text{ V},$ see fig. 6 and 13 ^b	-	-	5.8	nC
Gate-Drain Charge	Q _{gd}			-	-	11	
Turn-On Delay Time	t _{d(on)}			-	13	-	
Rise Time	t _r	V _{DD} :	= 30 V, I _D = 17 A,	-	58	-	
Turn-Off Delay Time	t _{d(off)}	$R_g = 18 \overline{\Omega},$	$R_D = 1.7 \Omega$, see fig. 10 ^b	-	25	-	ns
Fall Time	t _f			-	42	-	
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact - 42 - 4.5		-	- nH		
Internal Source Inductance	L _S			-			
Drain-Source Body Diode Characteristic	s				-		
Continuous Source-Drain Diode Current	I _S	MOSFET sym showing the	MOSFET symbol		-	20	Α
Pulsed Diode Forward Current ^a	I _{SM}	integral revers p - n junction		-	-	68	
Body Diode Voltage	V _{SD}	T _J = 25 °C	$I_{\rm S} = 17 \; {\rm A}, {\rm V}_{\rm GS} = 0 \; {\rm V}^{ {\rm b}}$	-	-	1.5	V
Body Diode Reverse Recovery Time	t _{rr}	т об ос и	17 A dl/dt 100 A / -	-	88	180	ns
Body Diode Reverse Recovery Charge	Q _{rr}	$T_{1} = 25 \text{ °C}$, $I_{5} = 17 \text{ A}$, $dI/dt = 100 \text{ A/us}$		0.64	μC		
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L_S and L_D)			L _D)		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width \leq 300 µs; duty cycle \leq 2 %.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

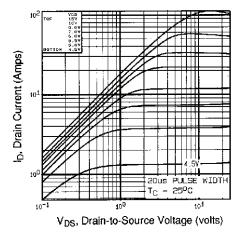


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

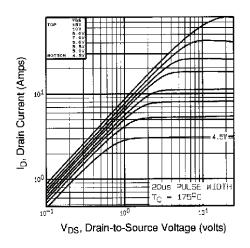


Fig. 2 - Typical Output Characteristics, $T_C = 175 \ ^{\circ}C$

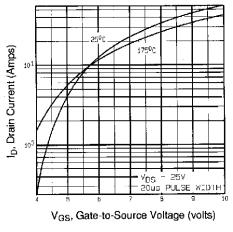


Fig. 3 - Typical Transfer Characteristics

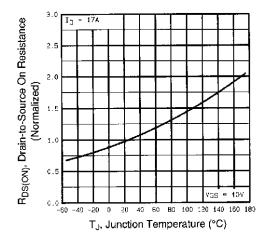


Fig. 4 - Normalized On-Resistance vs. Temperature

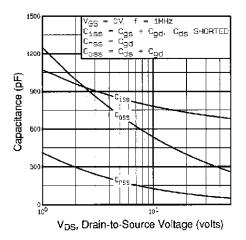


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

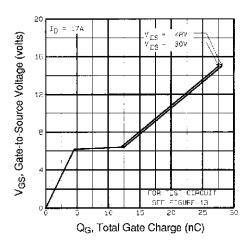


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



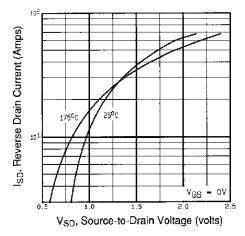


Fig. 7 - Typical Source-Drain Diode Forward Voltage

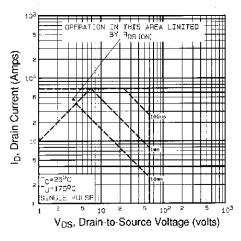


Fig. 8 - Maximum Safe Operating Area

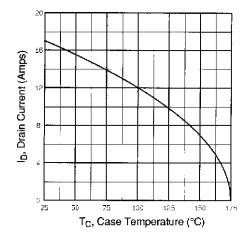


Fig. 9 - Maximum Drain Current vs. Case Temperature

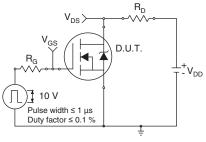


Fig. 10a - Switching Time Test Circuit

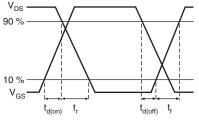
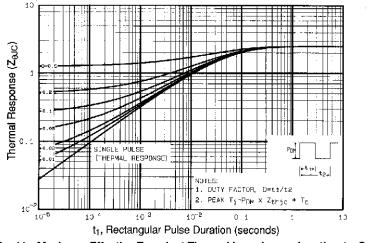


Fig. 10b - Switching Time Waveforms







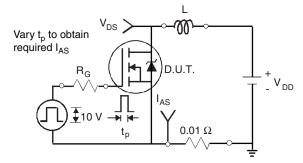


Fig. 12a - Unclamped Inductive Test Circuit

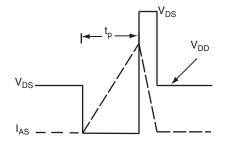


Fig. 12b - Unclamped Inductive Waveforms

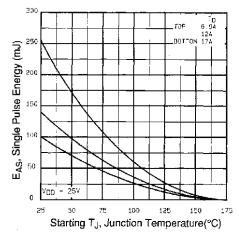


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

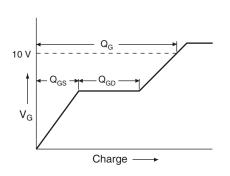


Fig. 13a - Basic Gate Charge Waveform

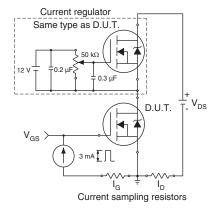
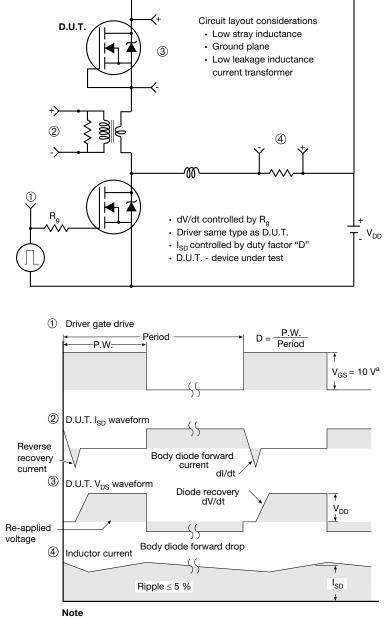


Fig. 13b - Gate Charge Test



Peak Diode Recovery dV/dt Test Circuit

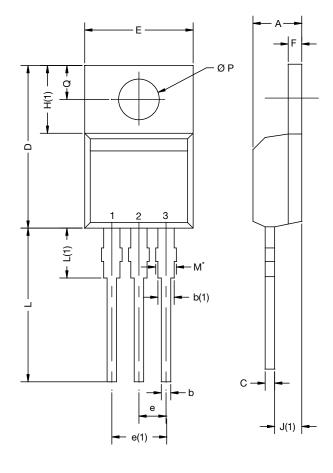


a. $V_{GS} = 5 V$ for logic level devices

Fig. 14 - For N-Channel



TO-220



	MILLIN	IETERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
с	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
Е	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØР	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	
ECN: X15-0 DWG: 6031	0364-Rev. C, 1	14-Dec-15			

Note

- M^{\star} = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



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